

/ Introduction of Hybrid Filler

A precision-designed filler that “optimally blends” Thermalnite® and spherical particles to build highly efficient thermal conduction paths



/ Specifications & Features

Optimized surface treatment for improved filler loading and flowability

NEW

	Thermalnite® Fiber Diameter	Spherical AlN Filler (with Thermalnite®)	Features
Ultra-Fine Particle Type	Fiber diameterD50 : 5μm Fiber lengthD50 : 20μm	Particle size D90 : TBD	Ideal for ultra-thin adhesive applications.
Small Particle Type	Fiber diameterD50 : 5μm Fiber lengthD50 : 20μm	Particle size D90 : 60μm	Optimized for thin-film applications
Large Particle Type	Fiber diameterD50 : 5μm Fiber lengthD50 : 20μm	Particle size D90 : 180μm	Enables higher thermal conductivity

NEW

	Spherical Filler	Ultra-Fine Particle Type	Small Particle Type	Large Particle Type
Structure				
Filler Loading				
Thermal Conductivity				
Mechanical Strength / Flexibility				

/ Example: Filler Loading vs Thermal Conductivity

NEW

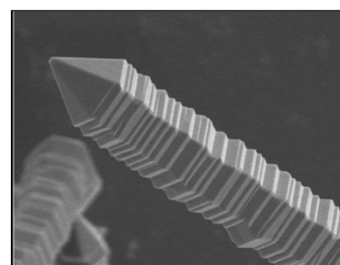
	Ultra-Fine Particle Type	Small Particle Type	Large Particle Type	
Resin Matrix	—	Silicone	Silicone	Epoxy
Filler Loading	40~60vol%	60vol%	80Vol%	80Vol%
Thickness	20~50μm	100~200μm	500~1000μm	500~1000μm
Thermal Conductivity	2.0~3.0W/m · K	4.5W/mK	12.5W/mK	15W/mK



/ Fibrous Aluminum Nitride Thermalnite®



Appearance	High aspect ratio, fibrous Fiber diameter D50: 5μm, Fiber length D50: 20μm
Chemical Formula	AlN
Crystal structure	Hexagonal wurtzite
Density	3.26g/cm ³
Mohs Hardness	9
Solubility	Almost insoluble in water
Reactivity	Hydrolysis is about 1/3 that of spherical AlN $\text{AlN} + 3\text{H}_2\text{O} \rightarrow \text{Al}(\text{OH})_3 + \text{NH}_3$



Main Applications

Resins such as silicone and epoxy
Ceramic substrates
(especially AlN substrates)

/ Comparison of Various Thermal Fillers

Aluminum nitride offers higher thermal conductivity and a lower thermal expansion coefficient than other ceramics, and because Thermalnite® is a single crystal, its thermal conductivity is even higher

Filler Material	Chemical Formula	Thermal Conductivity [W/m · K]	Mohs Hardness [Mohs]	Thermal Expansion Coeff. [ppm/K]	Density [g/cm ³]	Insulation [Ω · cm]
Thermalnite®	AlN	250	9	4.3~4.8	3.26	10¹⁴
Aluminum Nitride (Spherical)	AlN	170-230	7			
Silicon Nitride	Si ₃ N ₄	85	8~9	2.6~3.1	3.2~3.3	10 ¹³ ~ 10 ¹⁵
Alumina	Al ₂ O ₃	25~39	9	7~8	3.9	10 ¹⁴
Magnesia	MgO	40~60	6	11~13	3.6	10 ¹⁷

/ We also offer custom-designed hybrid fillers.

To further tailor a general-purpose hybrid filler to your required specifications, we can undertake PoC development for higher dispersion, including filling analysis that simulates the optimal blend ratio using machine learning and selection of the ideal surface treatment for the resin matrix. Please contact us for details.

※The blend ratio of the hybrid filler is not disclosed.

If required, an inspection certificate stating the following will be included upon product delivery.

1. Specific surface area measurement results
2. Particle size distribution measurement results
 - D50 values of major axis, minor axis, major-axis volume, and minor-axis volume
 - Cumulative probability graphs of fiber diameter and fiber length



Contact us ▲